



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Felton et al.

Atty. Docket: 2550/176

Serial No.: 10/657,741

Art Unit: 2856

Filing Date: September 8, 2003

Date: October 25, 2004

Invention: WAFER LEVEL CAPPED SENSOR

Examiner: Daniel S. Larkin

Certificate of Mailing

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, PO Box 1450 Alexandria, VA 22313-1450 on October 25, 2004.

Steven G. Saunders

AMENDMENT

Sir:

In response to the office action dated July 7, 2004, please amend the above-identified patent application as follows:

Amendments to the Specification begin on page 2 of this paper and include 1) a first attached substitute specification with markups, and 2) a second attached substitute specification without markups.

Amendments to the Claims are listed beginning on page 3 of this paper.

Amendments to the Drawings begin on page 5 of this paper and include an attached replacement sheet.

Remarks begin on page 6 of this paper.